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A. Patent Application No.(s):
09/342,801

B. Patent No.(s):

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: HAROLD L. BURSTYN

Internal Address: AFRL/IFOJ

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1

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CONFIRMATORY LICENSE

U.S. Patent Application for HERMETIC CHIP-SCALE PACKAGE FOR PHOTONIC DEVICES

Inventor(s): JOHNSON, Klein L. Honeywell Case No.: H16-25073 US

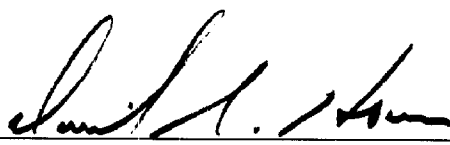
U.S. Serial No.: 09/342,801 Contract No.: F30602-97-2-0120
Filing Date: 06/29/99 Contractor: HONEYWELL INC.

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Signed this 26 day of September, 1999

HONEYWELL INC.

By: 
David S. Hoiriis
Vice President & Associate General Counsel
Intellectual Property
Honeywell Plaza
Minneapolis, Minnesota 55408

Corporate Seal